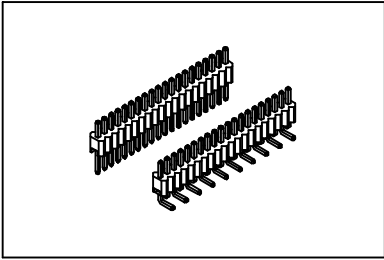


Pin Header 1.27mm(0.050")

GXCON



Features:

- * Choice of through-hole and surface mount.
- * Very low profile 2.54mm(0.10").
- * Custom design offered.
- * Two different foot print for surface mount design.

Material:

Housing: High temperature housing withstands IR and VPR soldering methods.

Contacts: Brass.

Plating: Gold plated over nickel.
Tin plated over nickel.

Selective gold plated: Gold plated on mating area and tin plated on solder tail.

Electrical Characteristics:

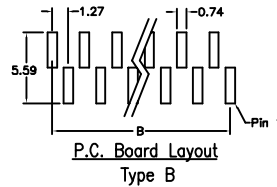
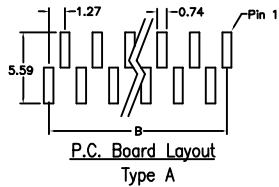
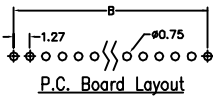
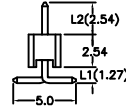
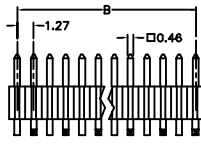
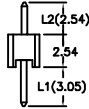
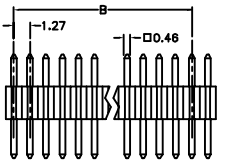
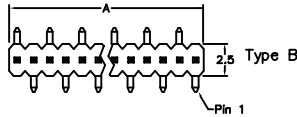
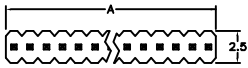
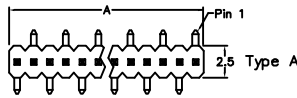
Current Rating: 1 AMP.

Insulator Resistance: 5000MΩ min. at DC 500V.

Contact Resistance: 20mΩ max. at DC 100mA.

Operating Temperature: -65°C ~ +125°C.

Max Processing Temperature: 230°C for 30~60 seconds.



Position	2 Thru 50
Dimension	
A	1.27 X No. of Positions
B	1.27 X No. of Positions - 1.27

Ordering information

PH22- 1 50 1 1 A /L1 /L2
 Series Single Row No. of Pin Per Row 3: Selective Gold Plated 1: Straight *Foot Print
 1: Gold Plated 3: Surface Mount Type A & B
 2: Tin Plated
 Custom Design: Straight (i.e. PH22-15011/L1 /L2)
 Surface mount (i.e. PH22-13213A/L1 / L2)